

Product Summary

Device	BV _{DSS}	Rds(on) Max	I _D Max T _A = +25°C
01	<u>cov</u> (1.7Ω @ V _{GS} = 10V	500mA
Q1	60V	3Ω @ V _{GS} = 4.5V	400mA
	001/	4Ω @ V _{GS} = -10V	-360mA
Q2	-60V	6Ω @ V _{GS} = -4.5V	-310mA

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- General-purpose interfacing switches
- Power-management functions
- Analog switches

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface-Mount Package
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMG1029SVQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SOT563
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish—Matte Tin Annealed Over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)

 Q_2

• Weight: 0.027 grams (Approximate)



Top View





Part Number	Paakaga	Packing			
	Package	Qty.	Carrier		
DMG1029SVQ-7	SOT563	3000	Tape & Reel		
DMG1029SVQ-7A	SOT563	3000	Tape & Reel		

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information

Notes:

Date Code Key			GA •	1 YM	Y Y	A1 = Produ M = Date C or \overline{Y} = Yea = Month (i	Code Marki ar (ex: K = 1	ng 2023)	de			
Year	2021		2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	I		K	L	М	N	Р	R	S	Т	U	V
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



Maximum Ratings N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		Vdss	60	V	
Gate-Source Voltage		Vgss	±20	V	
	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	500 400	mA
Continuous Drain Current (Note 6) V _{GS} = 10V	t < 10s	T _A = +25°C T _A = +70°C	ID	620 480	mA
Maximum Body Diode Forward Current (Note 6)		ls	500	mA	
Pulsed Drain Current (Note 6)	Ідм	1000	mA		
Pulsed Source Current (Note 6)	lsм	1000	mA		

Maximum Ratings P-CHANNEL – Q2 (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		Vdss	-60	V	
Gate-Source Voltage		V _{GSS}	±20	V	
	Steady State	T _A = +25°C T _A = +70°C	lo	-360 -280	mA
Continuous Drain Current (Note 6) V _{GS} = -10V	t < 10s	T _A = +25°C T _A = +70°C	ID	-410 -320	mA
Maximum Body Diode Forward Current (Note 6)		Is	-360	mA	
Pulsed Drain Current (Note 6)	Ідм	-650	mA		
Pulsed Source Current (Note 6)		lsм	-650	mA	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Dowar Dissinction (Note 5)	T _A = +25°C	Da	0.45	w
Total Power Dissipation (Note 5)	T _A = +70°C	PD	0.28	vv
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	281	°C/W
mermai Resistance, Sunction to Ambient (Note 5)	t < 10s	RθJA	210	C/W
Total Power Dissipation (Note 6)	T _A = +25°C	D-	1	W
Total Power Dissipation (Note 6)	T _A = +70°C	PD	0.62	vv
Thermal Registerion Junction to Ambient (Note 6)	Steady State	D	129	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t < 10s	R _{θJA}	97	C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



Electrical Characteristics N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)			•	•		•	
Drain-Source Breakdown Voltage	BVDSS	60	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}C$	IDSS	—	_	10	nA	V _{DS} =50V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±50	nA	$V_{GS} = \pm 5V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	VGS(TH)	1.0	—	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	RDS(ON)	_	1.3	1.7	Ω	$V_{GS} = 10V, I_D = 500mA$	
		—	1.5	3	12	$V_{GS} = 4.5V, I_D = 200mA$	
Forward Transfer Admittance	Yfs	80			mS	$V_{DS} = 10V, I_{D} = 200mA$	
Diode Forward Voltage	Vsd	_	_	1.4	V	Vgs = 0V, Is = 115mA	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	—	30		pF		
Output Capacitance	Coss	—	4.2		pF	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	2.9	_	pF		
Total Gate Charge	Qg	_	0.3	—	nC		
Gate-Source Charge	Qgs		0.2	—	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$ ID = 250mA	
Gate-Drain Charge	Qgd	_	0.08	—	nC		
Turn-On Delay Time	tD(ON)	_	3.9	—	ns		
Turn-On Rise Time		_	3.4	—	ns	V _{DD} = 30V, V _{GS} = 10V,	
Turn-Off Delay Time	t _{D(OFF)}		15.7	—	ns	$R_{G} = 25\Omega, I_{D} = 200 \text{mA}$	
Turn-Off Fall Time	tF	_	9.9		ns	7	

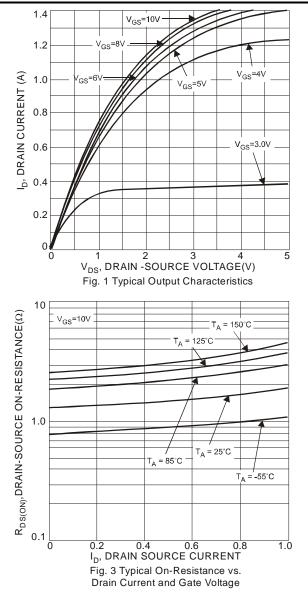
Electrical Characteristics P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

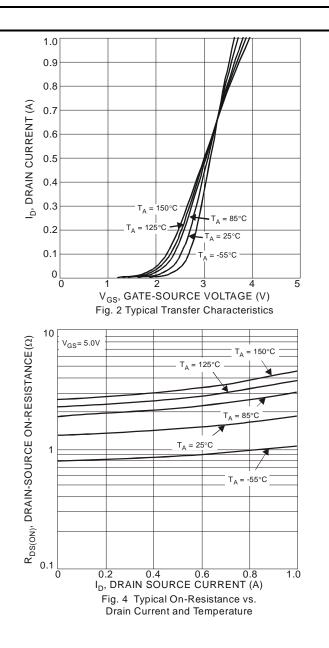
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	-60			V	Vgs = 0V, Ip = -250µA
Zero Gate Voltage Drain Current @T _C = +25°C	IDSS	_		-25	nA	V _{DS} = -50V, V _{GS} = 0V
Gate-Source Leakage	lgss	_		±100	nA	$V_{GS} = \pm 5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	-1	_	-3.0	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$
Statia Drain Source On Registeres		_	2.7	4	Ω	$V_{GS} = -10V, I_D = -500mA$
Static Drain-Source On-Resistance	RDS(ON)	_	3.2	6	Ω	Vgs = -4.5V, ID = -200mA
Forward Transfer Admittance	Y _{FS}	50	—	—	mS	V _{DS} = -25V, I _D = -100mA
Diode Forward Voltage	V _{SD}		_	-1.4	V	$V_{GS} = 0V, I_{S} = -115mA$
DYNAMIC CHARACTERISTICS (Note 8)				•	•	·
Input Capacitance	Ciss	—	25	_	pF	
Output Capacitance	Coss		4.7	_	pF	$V_{DS} = -25V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	2.7	—	pF	
Total Gate Charge	Qg		0.28	_	nC	
Gate-Source Charge	Qgs		0.14	_	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$
Gate-Drain Charge	Qgd		0.08		nC	I _D = -500mA
Turn-On Delay Time	tD(ON)		5.5		ns	
Turn-On Rise Time			7.9		ns	V _{DD} = -30V, V _{GS} = -10V,
Turn-Off Delay Time	tD(OFF)	_	10.6	—	ns	$R_{G} = 50\Omega, I_{D} = -270 \text{mA}$
Turn-Off Fall Time	tF	—	11.6	—	ns	1

Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.



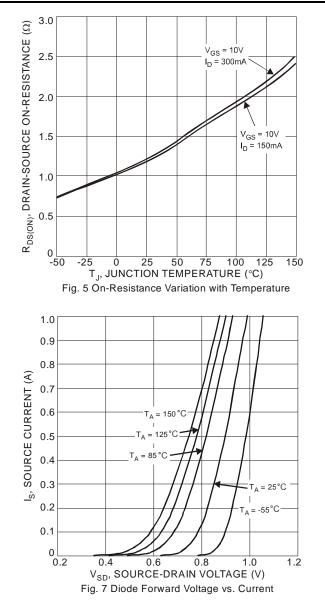
N-CHANNEL - Q1

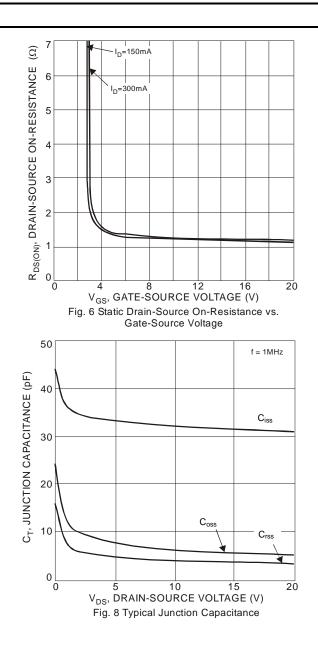






N-CHANNEL - Q1 (continued)



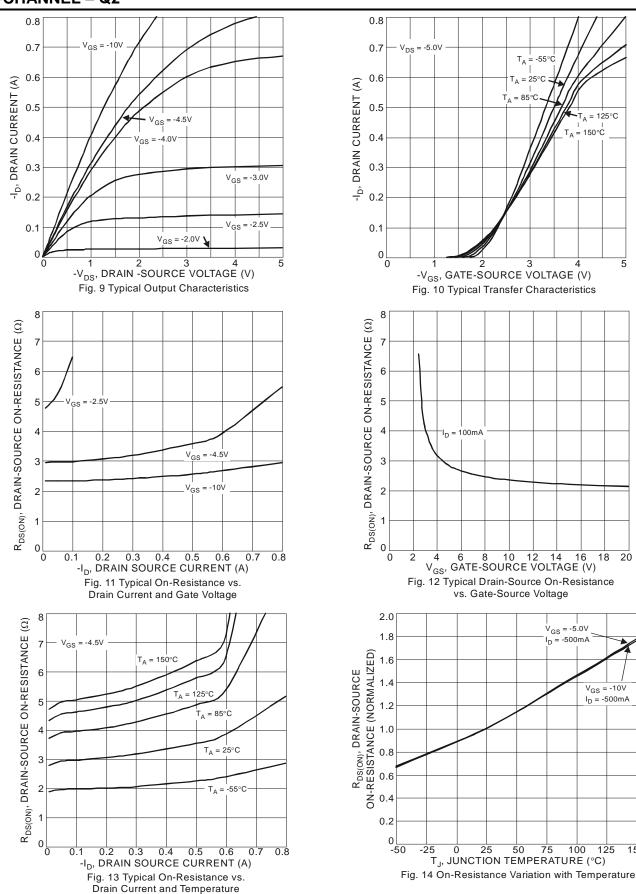




P-CHANNEL – Q2

5

18 20

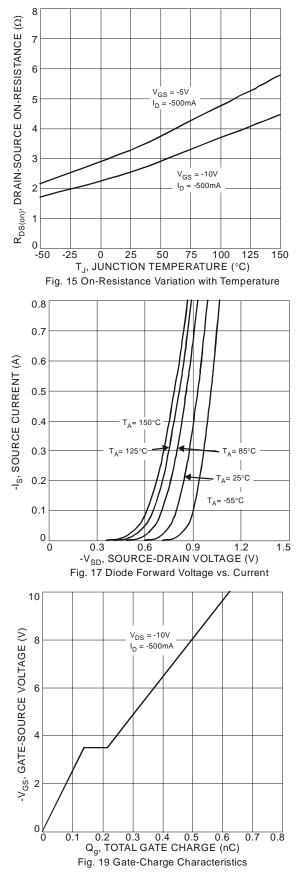


125

150



P-CHANNEL - Q2 (continued)



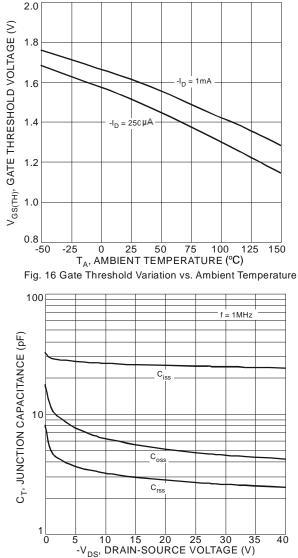
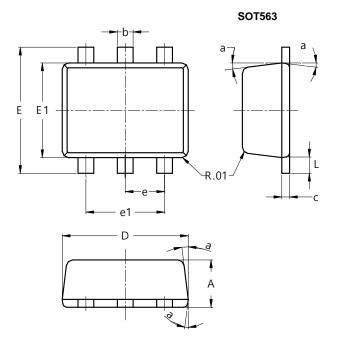


Fig. 18 Typical Junction Capacitance



Package Outline Dimensions

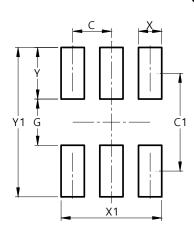
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SO	T563	
Dim	Min	Max	Тур
Α	0.55	0.60	
b	0.15	0.30	0.20
С	0.10	0.18	0.11
D	1.50	1.70	1.60
Е	1.55	1.70	1.60
E1	1.10	1.25	1.20
е			0.50
e1	0.90	1.10	1.00
L	0.10	0.30	0.20
а	8°	9°	7°
All	Dimens	sions in	mm

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)			
С	0.500			
C1	1.270			
G	0.600			
Х	0.300			
X1	1.300			
Y	0.670			
Y1	1.940			

SOT563



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